5V ECL Triple 2:1 Multiplexer

Description

The MC100EL59 is a triple 2:1 multiplexer with differential outputs. The output data of the multiplexers can be controlled individually via the select inputs or as a group via the common select input. The flexible selection scheme makes the device useful for both data path and random logic applications.

The 100 Series Contains Temperature Compensation

Features

- Individual or Common Select Controls
- 500 ps Typical Propagation Delays
- PECL Mode Operating Range: V_{CC} = 4.2 V to 5.7 V with V_{EE} = 0 V
- NECL Mode Operating Range: V_{CC} = 0 V with V_{EE} = -4.2 V to -5.7 V
- $\bullet\,$ Q Output will Default LOW with Inputs Open or at V_{EE}
- Internal Input Pulldown Resistors
- ESD Protection: Human Body Model; > 2 kV
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level:

Pb = 1 Pb-Free = 3

For Additional Information, see Application Note AND8003/D

- Flammability Rating: UL 94 V-0 @ 1.125 in, Oxygen Index: 28 to 34
- Transistor Count = 182 devices
- Pb-Free Package is Available*



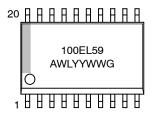
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SO-20 WB SUFFIX CASE 751D

MARKING DIAGRAM*



A = Assembly Location

WL = Wafer Lot
 YY = Year
 WW = Work Week
 G = Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

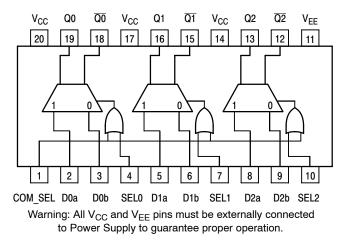


Figure 1. Logic Diagram and Pinout: 20-Lead SOIC (Top View)

Table 1. PIN DESCRIPTION

| PIN | FUNCTION |
|--------------------------------------|------------------------------|
| D0a-D2a | ECL Input Data a* |
| D0b-D2b | ECL Input Data b* |
| SEL0-SEL2 | ECL Individual Select Input* |
| COM_SEL | ECL Common Select Input* |
| Q0-Q2; Q0 - Q2 | ECL Differential Outputs |
| V _{CC} | Positive Supply |
| V _{EE} | Negative Supply |

^{*}Pins will default LOW when left open.

Table 2. TRUTH TABLE

| SEL* | DATA |
|------|------|
| Н | а |
| L | b |

^{*}Pins will default LOW when left open.

Table 3. MAXIMUM RATINGS

| Symbol | Parameter | Condition 1 | Condition 2 | Rating | Unit |
|-------------------|--|--|---|-------------------|--------------|
| V _{CC} | PECL Mode Power Supply | V _{EE} = 0 V | | 8 to 0 | ٧ |
| V _{EE} | NECL Mode Power Supply | V _{CC} = 0 V | | -8 to 0 | V |
| VI | PECL Mode Input Voltage NECL Mode Input Voltage | V _{EE} = 0 V V _{CC} = 0 V | $\begin{array}{c} V_I \! \leq \! V_{CC} \\ V_I \! \geq \! V_{EE} \end{array}$ | 6 to 0 -6 to 0 | V V |
| l _{out} | Output Current | Continuous Surge | | 50 100 | mA mA |
| T _A | Operating Temperature Range | | | -40 to +85 | °C |
| T _{stg} | Storage Temperature Range | | | -65 to +150 | °C |
| $\theta_{\sf JA}$ | Thermal Resistance (Junction-to-Ambient) | 0 lfpm 500 lfpm | SOIC-20 SOIC-20 | 90 60 | °C/W °C/W |
| $\theta_{\sf JC}$ | Thermal Resistance (Junction-to-Case) | Standard Board | SOIC-20 | 30 to 35 | °C/W |
| T _{sol} | Wave Solder Pb Pb-Free | | | 265 265 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 4. PECL DC CHARACTERISTICS V_{CC} = 5.0 V; V_{EE} = 0.0 V (Note 1)

| | | | -40°C | | | 25°C | | | 85°C | | |
|-----------------|------------------------------|------|-------|------|------|------|------|------|------|------|------|
| Symbol | Characteristic | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| I _{EE} | Power Supply Current | | 130 | 156 | | 130 | 156 | | 130 | 156 | mA |
| I _{EE} | Power Supply Current | | 27 | 32 | | 27 | 32 | | 27 | 32 | mA |
| V _{OH} | Output HIGH Voltage (Note 2) | 3915 | 3995 | 4120 | 3975 | 4045 | 4120 | 3975 | 4050 | 4120 | mV |
| V _{OL} | Output LOW Voltage (Note 2) | 3170 | 3305 | 3445 | 3190 | 3295 | 3380 | 3190 | 3295 | 3380 | mV |
| V _{IH} | Input HIGH Voltage | 3835 | | 4120 | 3835 | | 4120 | 3835 | | 4120 | mV |
| V _{IL} | Input LOW Voltage | 3190 | | 3525 | 3190 | | 3525 | 3190 | | 3525 | mV |
| I _{IH} | Input HIGH Current | | | 150 | | | 150 | | | 150 | μΑ |
| I _{IL} | Input LOW Current | 0.5 | | | 0.5 | | | 0.5 | | | μΑ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 1. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.8 V / -0.5 V. 2. Outputs are terminated through a 50 Ω resistor to V_{CC} 2.0 V.

Table 5. NECL DC CHARACTERISTICS V_{CC} = 0.0 V; V_{EE} = -5.0 V (Note 3)

| | | | -40°C | | | 25°C | | | 85°C | | |
|-----------------|------------------------------|-------|-------|-------|-------|-------|-------|-------|-------|-------|------|
| Symbol | Characteristic | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| I _{EE} | Power Supply Current | | 27 | 32 | | 27 | 32 | | 27 | 32 | mA |
| V _{OH} | Output HIGH Voltage (Note 4) | -1085 | -1005 | -880 | -1025 | -955 | -880 | -1025 | -955 | -880 | mV |
| V _{OL} | Output LOW Voltage (Note 4) | -1830 | -1695 | -1555 | -1810 | -1705 | -1620 | -1810 | -1705 | -1620 | mV |
| V _{IH} | Input HIGH Voltage | -1165 | | -880 | -1165 | | -880 | -1165 | | -880 | mV |
| V _{IL} | Input LOW Voltage | -1810 | | -1475 | -1810 | | -1475 | -1810 | | -1475 | mV |
| I _{IH} | Input HIGH Current | | | 150 | | | 150 | | | 150 | μΑ |
| I _{IL} | Input LOW Current | 0.5 | | | 0.5 | | | 0.5 | | | μΑ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 3. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.8 V / -0.5 V. 4. Outputs are terminated through a 50 Ω resistor to V_{CC} 2.0 V.

Table 6. AC CHARACTERISTICS $V_{CC} = 5.0 \text{ V}$; $V_{EE} = 0.0 \text{ V}$ or $V_{CC} = 0.0 \text{ V}$; $V_{EE} = -5.0 \text{ V}$ (Note 5)

| | | | -40°C | | | 25°C | | | 85°C | | |
|--------------------------------------|---|-------------------|-------|-------------------|-------------------|------|-------------------|-------------------|------|-------------------|------|
| Symbol | Characteristic | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| t _{PLH} t _{PHL} | $ \begin{array}{ccc} \text{Propagation} & \text{DATA to } Q/\overline{Q} \\ \text{Delay} & \text{SEL to } Q/\overline{Q} \\ \text{COM_SEL to } Q/\overline{Q} \\ \end{array} $ | 340 340 340 | | 690 690 690 | 340 340 340 | | 690 690 690 | 340 340 340 | | 690 690 690 | ps |
| t _{skew} | Output-Output Skew Any D_n , D_m to Q | | | 100 | | | 100 | | | 100 | ps |
| tJITTER | Cycle-to-Cycle Jitter | | TBD | | | TBD | | | TBD | | ps |
| t _r t _f | Output Rise/Fall Times Q (20% – 80%) | 200 | | 540 | 200 | | 540 | 200 | | 540 | ps |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. V_{EE} can vary +0.8 V / -0.5 V.

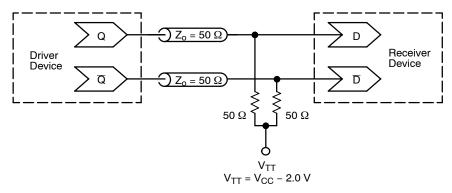


Figure 2. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|--------------|----------------------|-----------------------|
| MC100EL59DW | SOIC-20 | 38 Units / Rail |
| MC100EL59DWG | SOIC-20 (Pb-Free) | 38 Units / Rail |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Resource Reference of Application Notes

AN1405/D - ECL Clock Distribution Techniques

AN1406/D - Designing with PECL (ECL at +5.0 V)

AN1503/D - ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

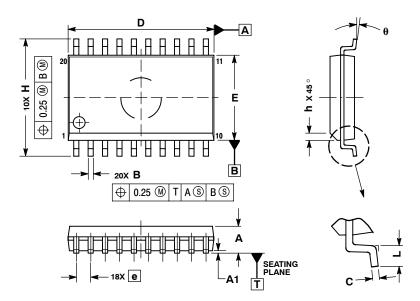
AND8020/D - Termination of ECL Logic Devices

AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

PACKAGE DIMENSIONS

SO-20 WB CASE 751D-05 **ISSUE G**



- NOTES:
 1. DIMENSIONS ARE IN MILLIMETERS.
 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 PER SIDE. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

| | MILLIMETERS | | | | | | | |
|-----|-------------|-------|--|--|--|--|--|--|
| DIM | MIN | MAX | | | | | | |
| Α | 2.35 | 2.65 | | | | | | |
| A1 | 0.10 | 0.25 | | | | | | |
| В | 0.35 | 0.49 | | | | | | |
| C | 0.23 | 0.32 | | | | | | |
| D | 12.65 | 12.95 | | | | | | |
| E | 7.40 | 7.60 | | | | | | |
| е | 1.27 | BSC | | | | | | |
| Н | 10.05 | 10.55 | | | | | | |
| h | 0.25 | 0.75 | | | | | | |
| L | 0.50 | 0.90 | | | | | | |
| _ | n٥ | 70 | | | | | | |

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